APR 2 8 2005 No. Attorney's Docket No. 5308-156

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Ryu et al. Serial No.: 09/911,995 Filed: July 24, 2001 Group Art Unit: 2811 Confirmation No.: 5240 Examiner: Gene Munson

For: SILICON C

SILICON CARBIDE POWER METAL-OXIDE SEMICONDUCTOR FIELD EFFECT

TRANSISTORS HAVING A SHORTING CHANNEL AND METHODS OF

FABRICATING SILICON CARBIDE METAL-OXIDE SEMICONDUCTOR FIELD

EFFECT TRANSISTORS HAVING A SHORTING CHANNEL

Date: April 26, 2005]

Mail Stop RCE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

Attached is a list of documents on Form PTO-1449, together with a copy of any listed foreign patent document and/or non-patent literature. A copy of any listed U.S. patent and/or U.S. patent application publication is not provided herewith in accordance with the amendment by the U.S. Patent and Trademark Office to 37 C.F.R. § 1.98(a)(2)(ii) effective October 21, 2004. It is requested that these documents be considered by the Examiner and officially made of record in accordance with the provisions of 37 C.F.R. § 1.56 and Section 609 of the MPEP.

This Information Disclosure is submitted in accordance with 37 C.F.R. § 1.97(b)(4), before the mailing of a first action after the filing of a Request for Continued Examination under 37 C.F.R. § 1.114. Therefore, no fee is believed due. However, the Commissioner is hereby authorized to charge any deficiency or credit any overpayment to Deposit Account No. 50-0220.

Respectfully submitted,

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Traci A. Brown

FORM PTO-1449 U.S. Department Commerce Patent and Trademark Office LIST OF DOCUMENTS CITED BY APPLICANT	Attorney Docket Number: 5308-156	Serial No.: 09/911,995		
(Use several sheets if necessary)	Applicants: Ryu et al.			
	Filing Date: July 24, 2001	Group: 2811		

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EXAMINER

DATE CONSIDERED

*EXAMINER Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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